



30V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
	1.7mΩ @ V _{GS} = 10V	100A
30V	2.8mΩ @ V _{GS} = 4.5V	100A

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- Backlighting
- Power Management Functions
- DC-DC Converters

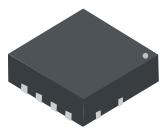
Features and Benefits

- Low RDS(ON) Ensures On-State Losses Are Minimized
- Excellent Q_{qd} × R_{DS(ON)} Product (FOM)
- Advanced Technology for DC-DC Converts
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies Just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- 100% UIS (Avalanche) Rated
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

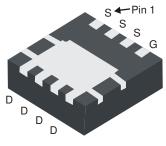
Mechanical Data

- Case: PowerDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminal Finish Matte Tin Annealed Over Copper Lead-Frame. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.008 grams (Approximate)

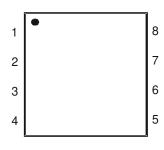
PowerDI3333-8



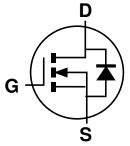
Top View



Bottom View



Top View



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMT32M4LFG-7	PowerDI3333-8	2,000/Tape & Reel
DMT32M4LFG-13	PowerDI3333-8	3,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

SK3

SK3 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 1 = 2021)

W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Key

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	1	2	3	4	5	6	7	8	9	0	1	2

Week	1-26	27-52	53
Code	A-Z	a-z	Z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	Т	U	V	W	Χ	Υ	Z

Maximum Ratings (@ T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	30	V
Gate-Source Voltage		Vgss	±20	V
Continuous Drain Current (Note 6) $V_{GS} = 10V$ $T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$		ID	100 100	Α
Continuous Drain Current (Note 6) V _{GS} = 10V	ID	30 24	Α	
Maximum Continuous Body Diode Forward Current (Note 5)		ls	2.8	Α
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)	Ірм	440	Α	
Pulsed Body Diode Forward Current (380µs Pulse, Duty Cycle =	Іѕм	440	Α	
Avalanche Current, L = 0.1mH	las	58	Α	
Avalanche Energy, L = 0.1mH	Eas	172	mJ	

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5) T _A = +25°C		PD	1.1	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	115	°C/W	
Total Power Dissipation (Note 6) $T_C = +25^{\circ}C$		PD	2.6	W
Thermal Resistance, Junction to Ambient (Note 6)	R _{0JA}	49	°C/W	
Thermal Resistance, Junction to Case (Note 6)	$R_{ heta JC}$	3.9	°C/W	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).



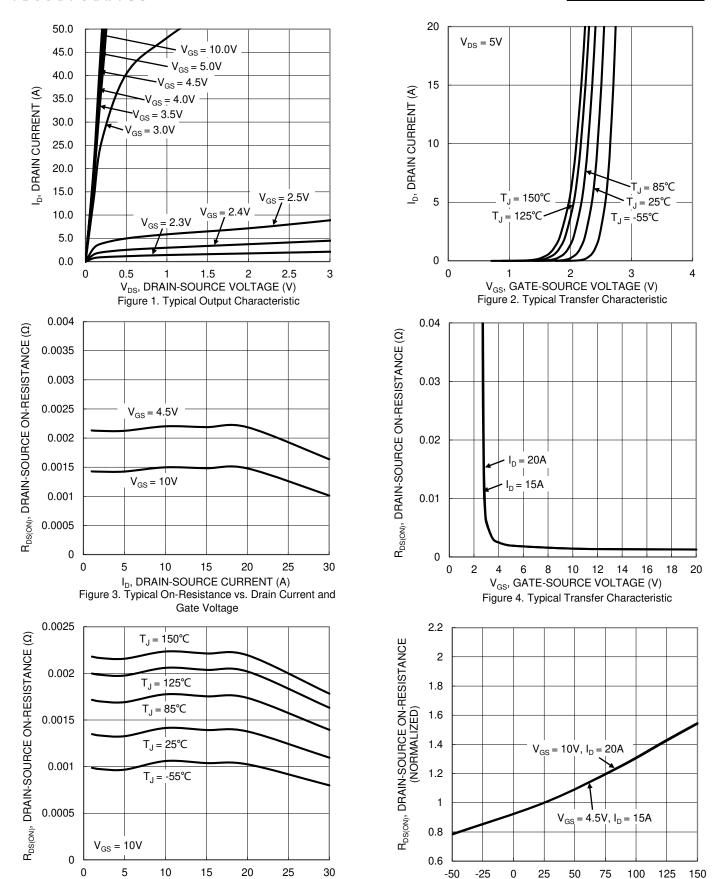
Electrical Characteristics (@TJ = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	VGS = 0V, ID = 1mA	
Zava Cata Valtana Duain Cumunut	1	_	_	1		$V_{DS} = 24V, V_{GS} = 0V$	
Zero Gate Voltage Drain Current	IDSS	_	_	10	μΑ	V _{DS} = 30V, V _{GS} = 0V	
Gate-Source Leakage	Igss		±10	μΑ	Vgs = 20V, Vps = 0V		
date outlee Leakage	1655			±10	μΛ	$V_{GS} = -16V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	1		3	V	$V_{DS}=V_{GS},I_D=250\mu A$	
Static Drain-Source On-Resistance	D	_	1.4	1.7	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	RDS(ON)	_	2.1	2.8	mΩ	VGS = 4.5V, ID = 15A	
Diode Forward Voltage	V _{SD}	_	0.7	1	V	Vgs = 0V, Is = 2A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	4366	_		.,	
Output Capacitance	Coss	_	1568	_	рF	V _{DS} = 15V, V _{GS} = 0V, f = 1MHz	
Reverse Transfer Capacitance	Crss	_	262	_		1 – 1101112	
Gate Resistance	Rg	_	0.86	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	33.5	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	67	_	nC	V 15V I- 00A	
Gate-Source Charge	Qgs	_	10.2	_	iiC	$V_{DS} = 15V, I_{D} = 20A$	
Gate-Drain Charge	Qgd	_	12.9	_			
Turn-On Delay Time	t _{D(ON)}	_	8	_			
Turn-On Rise Time	t _R	_	22	_		V _{DD} = 15V, V _{GS} = 10V,	
Turn-Off Delay Time	tD(OFF)	_	48	_	ns	$R_G = 3\Omega$, $I_D = 20A$	
Turn-Off Fall Time	t _F	_	29				

Notes:

^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.





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I_D, DRAIN CURRENT (A)

Figure 5. Typical On-Resistance vs. Drain Current and

 T_J , JUNCTION TEMPERATURE (°C)

Figure 6. On-Resistance Variation with Junction

Temperature



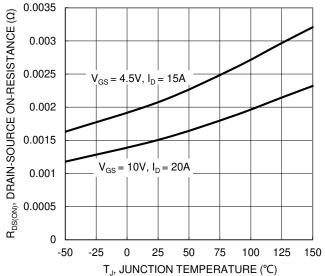
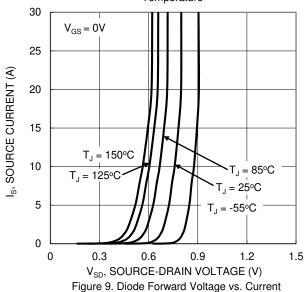
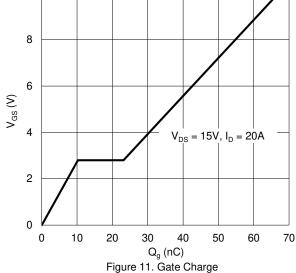


Figure 7. On-Resistance Variation with Junction Temperature



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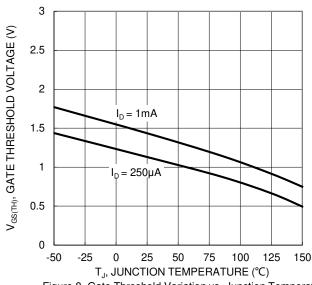
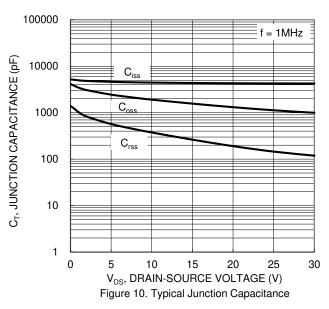
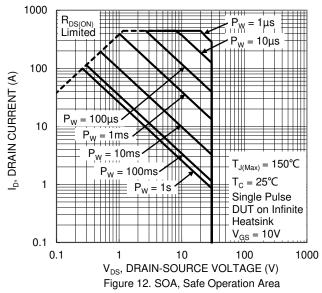


Figure 8. Gate Threshold Variation vs. Junction Temperature







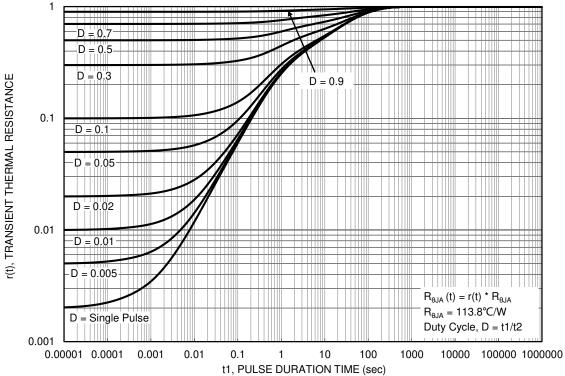


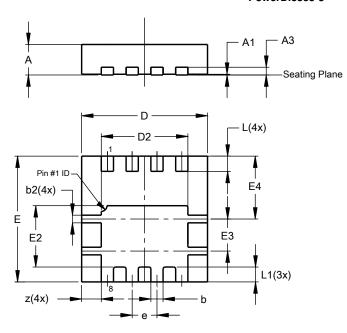
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

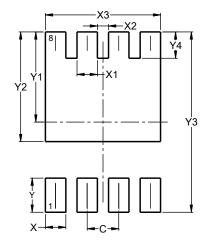


PowerDI3333-8						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05	0.02			
А3	_	_	0.203			
b	0.27	0.37	0.32			
b2	0.15	0.25	0.20			
D	3.25	3.35	3.30			
D2	2.22	2.32	2.27			
Е	3.25	3.35	3.30			
E2	1.56	1.66	1.61			
E3	0.79	0.89	0.84			
E4	1.60	1.70	1.65			
е	-	_	0.65			
L	0.35	0.45	0.40			
L1	_	_	0.39			
Z	_	_	0.515			
All [Dimens	sions ir	n mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	value (in mm)
С	0.650
X	0.420
X1	0.420
X2	0.230
Х3	2.370
Υ	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540

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